

HSM2836C

Silicon Epitaxial Planar Diode for High Speed Switching

REJ03G0554-0400

(Previous: ADE-208-030C)

Rev.4.00 Mar 10, 2005

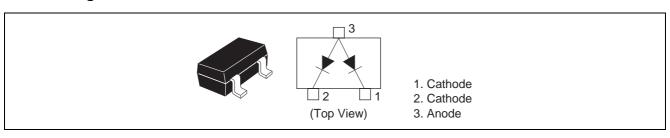
Features

- Fast recovery time.
- MPAK package is suitable for high density surface mounting and high speed assembly.

Ordering Information

| Type No. | Laser Mark | Package Name | Package Code (Previous Code) |
|----------|------------|--------------|---------------------------------|
| HSM2836C | A4 | MPAK | PLSP0003ZC-A |
| | | | (MPAK) |

Pin Arrangement



Absolute Maximum Ratings *1

 $(Ta = 25^{\circ}C)$

| Item | Symbol | Value | Unit |
|---|---------------------------------|-------------|------|
| Peak reverse voltage | V_{RM} | 85 | V |
| Reverse voltage | V _R | 80 | V |
| Peak forward current | I _{FM} | 300 | mA |
| Non-Repetitive peak forward surge current | I _{FSM} * ² | 4 | Α |
| Average rectified current | I ₀ | 100 | mA |
| Junction temperature | Tj | 125 | °C |
| Storage temperature | Tstg | -55 to +125 | °C |

Notes: 1. Per one device.

2. Within 1 μs forward surge current.

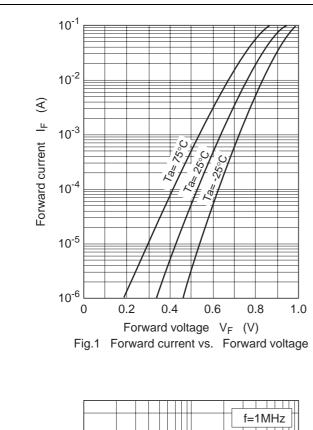
Electrical Characteristics *1

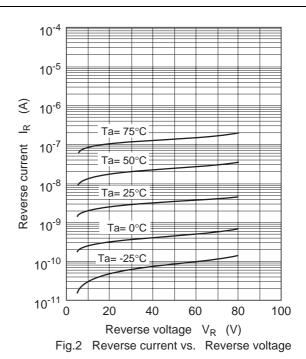
 $(Ta = 25^{\circ}C)$

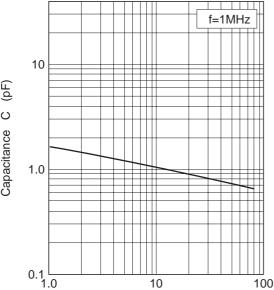
| Item | Symbol | Min | Тур | Max | Unit | Test Condition |
|-----------------------|-----------------|-----|------|-----|------|---|
| Forward voltage | V _{F1} | _ | 0.72 | 1.0 | V | I _F = 10 mA |
| | V_{F2} | _ | 0.83 | 1.0 | | I _F = 50 mA |
| | V _{F3} | _ | 0.90 | 1.2 | | I _F = 100 mA |
| Reverse current | I_R | _ | _ | 0.1 | μΑ | V _R = 80 V |
| Capacitance | С | _ | 2.5 | 4.0 | pF | V _R = 0 V, f = 1 MHz |
| Reverse recovery time | t _{rr} | _ | _ | 20 | ns | $I_F = 10 \text{ mA}, V_R = 6 \text{ V}, R_L = 50 \Omega$ |

Note: 1. Per one device.

Main Characteristic



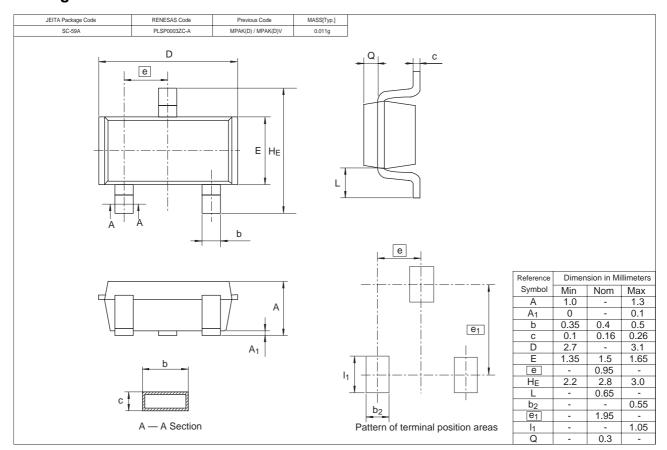




Capacitance C (pF) 0.1 1.0 Reverse voltage V_R (V)

Fig.3 Capacitance vs. Reverse voltage

Package Dimensions



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